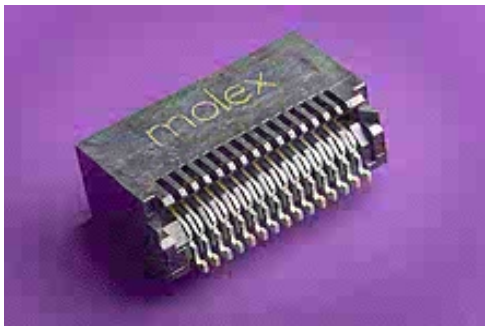
molex



Part Number : 744410017
Product Description : 0.80mm Pitch XFP Host Connector, Z-Axis Pluggable, Right-Angle, Surface Mount, 30 Circuits, 0.76µm Gold (Au)
Series Number : 74441
Status : Obsolete
Product Category : High-Speed I/O Connectors

Obsolete

Documents and Resources

Drawings

744410017_sd.pdf

PK-70873-1201-001.pdf

EE-74441-001-001.pdf

SP-74441-001-001.zip

Specifications

AS-74441-001-001.pdf

PS-74441-001-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)6375-DC (05 Nov 2025) SCIP:9b57ad9e-307b-418e-a95f-35bbea3c472a
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC

- Low-Halogen

Industry Documents
- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest
- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Obsolete
Category	High-Speed I/O Connectors
Series	74441
Description	0.80mm Pitch XFP Host Connector, Z-Axis Pluggable, Right-Angle, Surface Mount, 30 Circuits, 0.76µm Gold (Au)
Application	Module-to-Board
Component Type	Receptacle
Product Name	Z-Axis Pluggable
Type	N/A
UPC	756054467039

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	0.5A
Grounding to Panel	Yes
Shielded	No
Voltage - Maximum	30V AC (RMS)/DC

Obsolete

Physical

Boot Color	N/A
Circuits Detail	30
Circuits (Loaded)	30
Circuits (maximum)	30
Color - Resin	Black
Durability (mating cycles max)	200
Flammability	94V-0
Gender	Receptacle
Keying to Mating Part	Yes
Lock to Mating Part	Yes
Material - Metal	High Performance Alloy (HPA)
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	0.890/g
Number of Rows	2
Orientation	Right Angle
Packaging Type	Embossed Tape on Reel
Panel Mount	No
PCB Locator	Yes
PCB Retention	Yes
Pitch - Mating Interface	0.80mm
Pitch - Termination Interface	0.80mm
Plating min - Mating	0.762µm
Plating min - Termination	2.540µm
Polarized to Mating Part	Yes
Polarized to PCB	No
Ports	1
Temperature Range - Operating	-40° to +85°C
Termination Interface Style	Surface Mount
Waterproof / Dustproof	No
Wire Size (AWG)	N/A

Obsolete

Solder Process Data

Max-Duration	15
Lead-Free Process Capability	SMC&WAVE
Max-Cycle	1
Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description	Part Number
Mates With	XFP Modules

Obsolete